

# NPN-Silizium-Fototransistor Zeilen

## Silicon NPN Phototransistor Arrays

### Lead (Pb) Free Product - RoHS Compliant

**BPX 80**  
**BPX 82 ... 89**



#### Wesentliche Merkmale

- Speziell geeignet für Anwendungen im Bereich von 450 nm bis 1100 nm
- Hohe Linearität
- Mehrstellige Zeilenbauform aus klarem Epoxy
- Gruppiert lieferbar

#### Features

- Especially suitable for applications from 450 nm to 1100 nm
- High linearity
- Multiple-digit array package of transparent epoxy
- Available in groups

#### Anwendungen

- Miniaturlichtschranken für Gleich- und Wechsellichtbetrieb
- Industrieelektronik
- „Messen/Steuern/Regeln“

#### Applications

- Miniature photointerrupters
- Industrial electronics
- For control and drive circuits

Typ Type	Bestellnummer Ordering Code	Fotostrom , $E_e = 0.5 \text{ mW/cm}^2$ , $\lambda = 950 \text{ nm}$ , $V_{CE} = 5 \text{ V}$ Photocurrent $I_{PCE}$ (mA)
BPX 82	Q62702P0021	> 0.32
BPX 83	Q62702P0025	> 0.32
BPX 84	Q62702P0030	> 0.32
BPX 85	Q62702P0031	> 0.32
BPX 86	Q62702P0022	> 0.32
BPX 87	Q62702P0032	> 0.32
BPX 88	Q62702P0033	> 0.32
BPX 89	Q62702P0026	> 0.32
BPX 80	Q62702P0028	> 0.32

**Grenzwerte****Maximum Ratings**

<b>Bezeichnung Parameter</b>	<b>Symbol Symbol</b>	<b>Wert Value</b>	<b>Einheit Unit</b>
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{op}; T_{stg}$	- 40 ... + 80	°C
Kollektor-Emitterspannung Collector-emitter voltage	$V_{CE}$	35	V
Kollektorstrom Collector current	$I_C$	50	mA
Kollektorschwankstrom, $\tau < 10 \mu s$ Collector surge current	$I_{CS}$	200	mA
Verlustleistung, $T_A = 25 \text{ }^{\circ}\text{C}$ Total power dissipation	$P_{tot}$	90	mW
Wärmewiderstand Thermal resistance	$R_{thJA}$	750	K/W

**Kennwerte ( $T_A = 25^\circ\text{C}$ ,  $\lambda = 950 \text{ nm}$ )****Characteristics**

<b>Bezeichnung Parameter</b>	<b>Symbol Symbol</b>	<b>Wert Value</b>	<b>Einheit Unit</b>
Wellenlänge der max. Fotoempfindlichkeit Wavelength of max. sensitivity	$\lambda_{S_{\max}}$	850	nm
Spektraler Bereich der Fotoempfindlichkeit $S = 10\%$ von $S_{\max}$ Spectral range of sensitivity $S = 10\%$ of $S_{\max}$	$\lambda$	450 ... 1100	nm
Bestrahlungsempfindliche Fläche Radiant sensitive area	$A$	0.11	$\text{mm}^2$
Abmessung der Chipfläche Dimensions of chip area	$L \times B$ $L \times W$	$0.5 \times 0.5$	$\text{mm} \times \text{mm}$
Halbwinkel Half angle	$\phi$	$\pm 18$	Grad deg.
Kapazität Capacitance $V_{CE} = 0 \text{ V}, f = 1 \text{ MHz}, E = 0$	$C_{CE}$	7.5	pF
Dunkelstrom Dark current $V_{CE} = 20 \text{ V}, E = 0$	$I_{CEO}$	1 ( $\leq 50$ )	nA

**Die Fototransistoren werden nach ihrer Fotoempfindlichkeit gruppiert und mit Buchstaben gekennzeichnet.**

**The phototransistors are grouped according to their spectral sensitivity and distinguished by alphabetic characters.**

<b>Bezeichnung Parameter</b>	<b>Symbol Symbol</b>	<b>Werte Value</b>			<b>Einheit Unit</b>
		<b>-A</b>	<b>-B</b>	<b>-C</b>	
Fotostrom Photocurrent $E_e = 0.5 \text{ mW/cm}^2, \lambda = 950 \text{ nm}, V_{CE} = 5 \text{ V}$ $E_v = 1000 \text{ lx, Normlicht/standard light A, } V_{CE} = 5 \text{ V}$	$I_{PCE}$ $I_{PCE}$	0.32...0.63 1.5	0.40...0.80 1.9	$\geq 0.50$ 2.3	mA mA
Anstiegszeit/Abfallzeit Rise and fall time $I_C = 1 \text{ mA, } V_{CC} = 5 \text{ V, } R_L = 1 \text{ k}\Omega$	$t_r, t_f$	5.5	6	8	$\mu\text{s}$
Kollektor-Emitter-Sättigungsspannung Collector-emitter saturation voltage $I_C = I_{PCEmin}^{1)} \times 0.3,$ $E_e = 0.5 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$	$V_{CESat}$	150	150	150	mV

<sup>1)</sup>  $I_{PCEmin}$  ist der minimale Fotostrom der jeweiligen Gruppe.

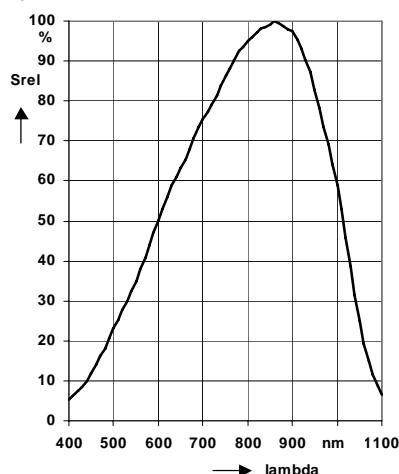
<sup>1)</sup>  $I_{PCEmin}$  is the min. photocurrent of the specified group.

Die gelieferten Bauelemente sind mit -A, -B, -C gekennzeichnet. Wegen Ausbeuteschwankungen ist jedoch die Bestellung einer definierten Gruppe -A, -B, -C nicht möglich.

For delivery the components are marked -A, -B, -C. Due to differing yields, it is not possible to order a definite group.

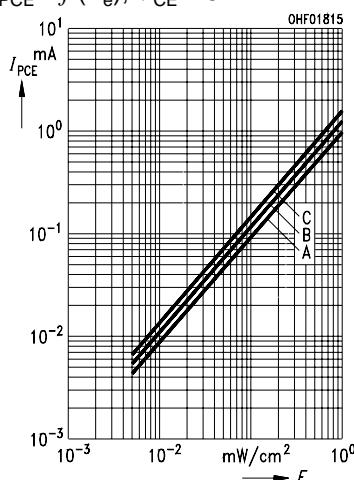
**Relative Spectral Sensitivity**

$$S_{\text{rel}} = f(\lambda)$$



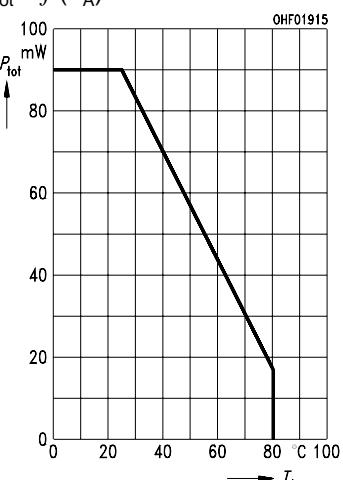
**Photocurrent**

$$I_{\text{PCE}} = f(E_e), V_{\text{CE}} = 5 \text{ V}$$



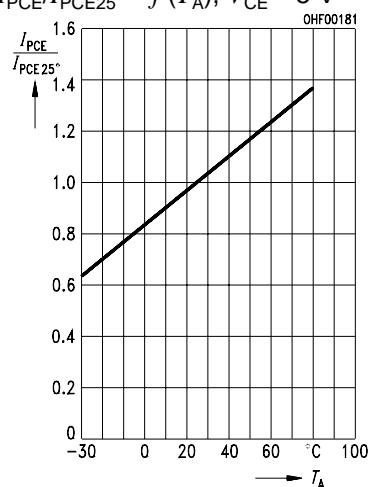
**Total Power Dissipation**

$$P_{\text{tot}} = f(T_A)$$



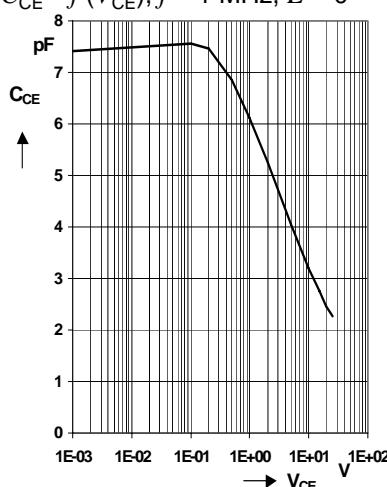
**Photocurrent**

$$I_{\text{PCE}}/I_{\text{PCE}25^\circ} = f(T_A), V_{\text{CE}} = 5 \text{ V}$$



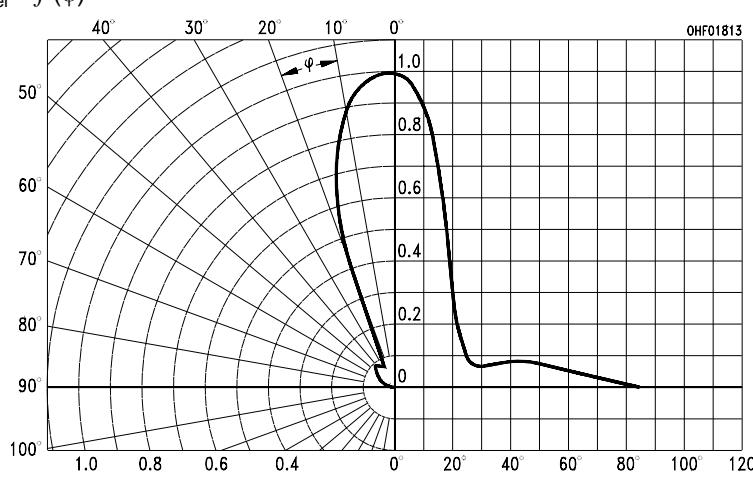
**Collector-Emitter Capacitance**

$$C_{\text{CE}} = f(V_{\text{CE}}), f = 1 \text{ MHz}, E = 0$$



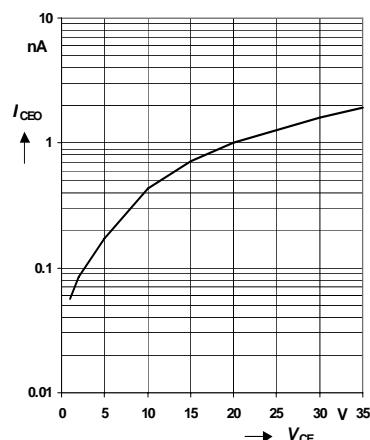
**Directional Characteristics**

$$S_{\text{rel}} = f(\varphi)$$



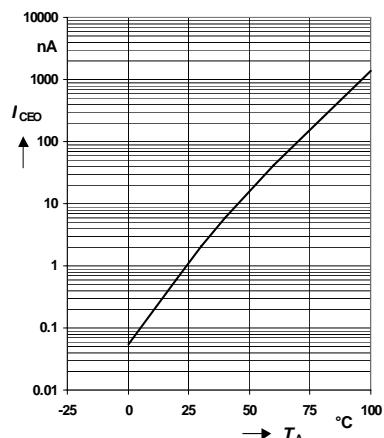
**Dark Current**

$$I_{\text{CEO}} = f(V_{\text{CE}}), E = 0$$

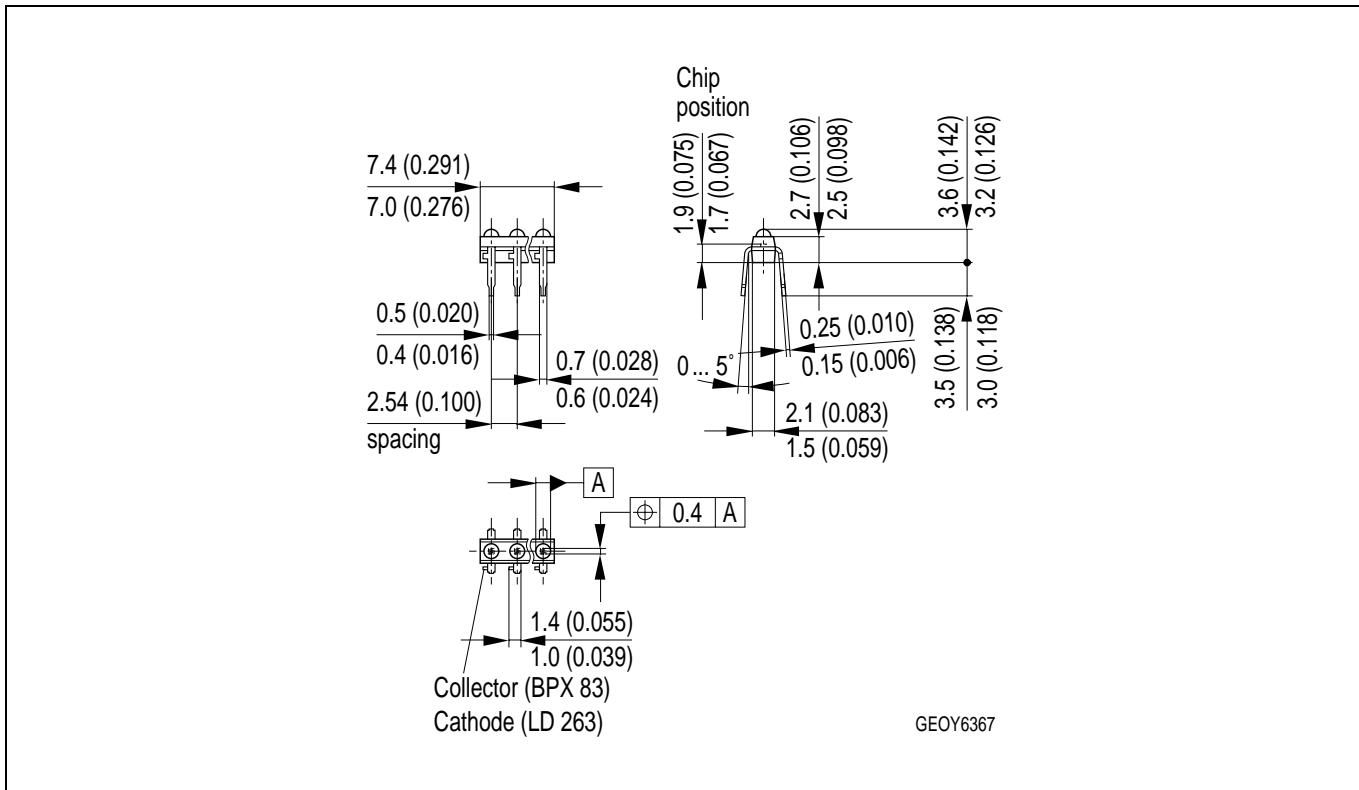


**Dark Current**

$$I_{\text{CEO}} = f(T_A), V_{\text{CE}} = 20 \text{ V}, E = 0$$

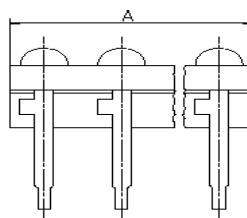


## Maßzeichnung Package Outlines



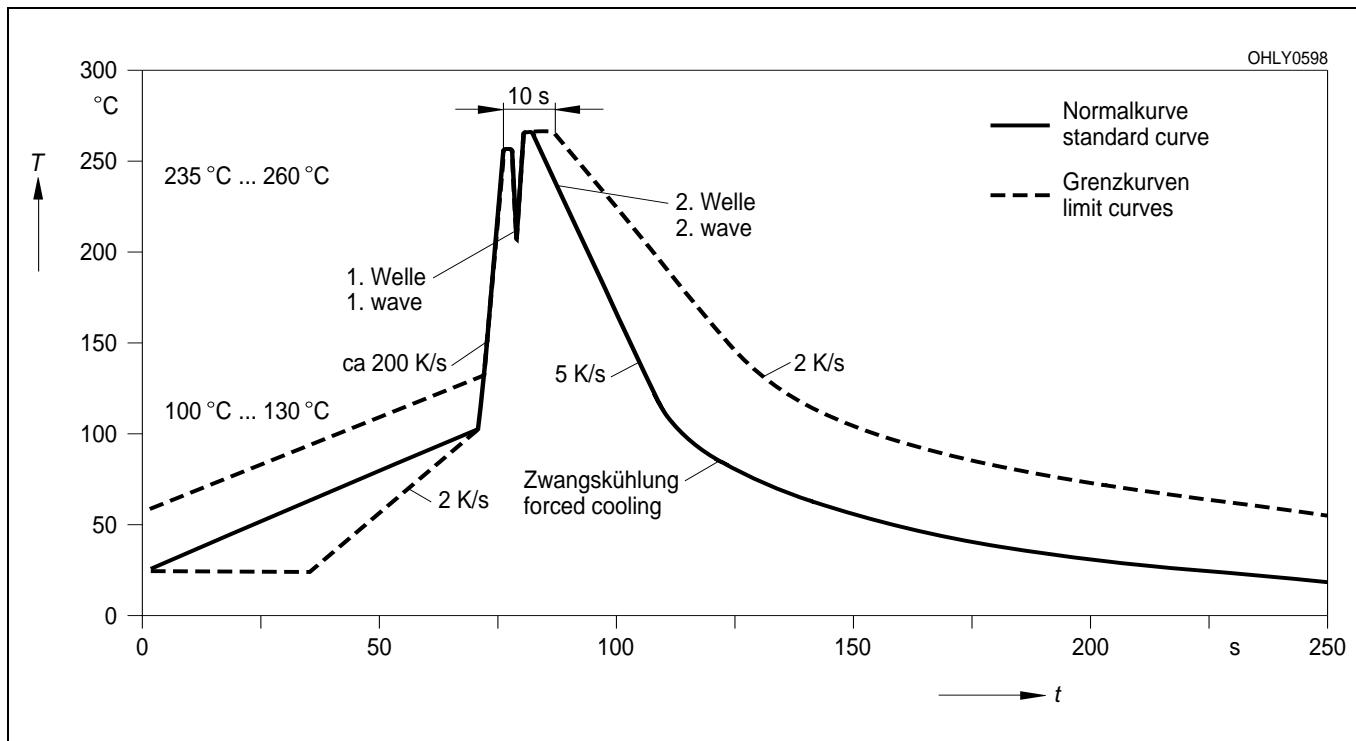
Maße in mm (inch) / Dimensions in mm (inch).

Transistoren pro Zeile Number of Transistors per Array	Maße „A“ Dimensions “A”
2	4.5 ... 4.9
3	7.0 ... 7.4
4	9.6 ... 10.0
5	12.1 ... 12.5
6	14.6 ... 16.0
7	17.2 ... 17.6
8	19.7 ... 20.1
9	22.3 ... 22.7
10	24.8 ... 25.2



**Lötbedingungen**  
**Soldering Conditions**  
**Wellenlöten (TTW)**  
**TTW Soldering**

(nach CECC 00802)  
 (acc. to CECC 00802)



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